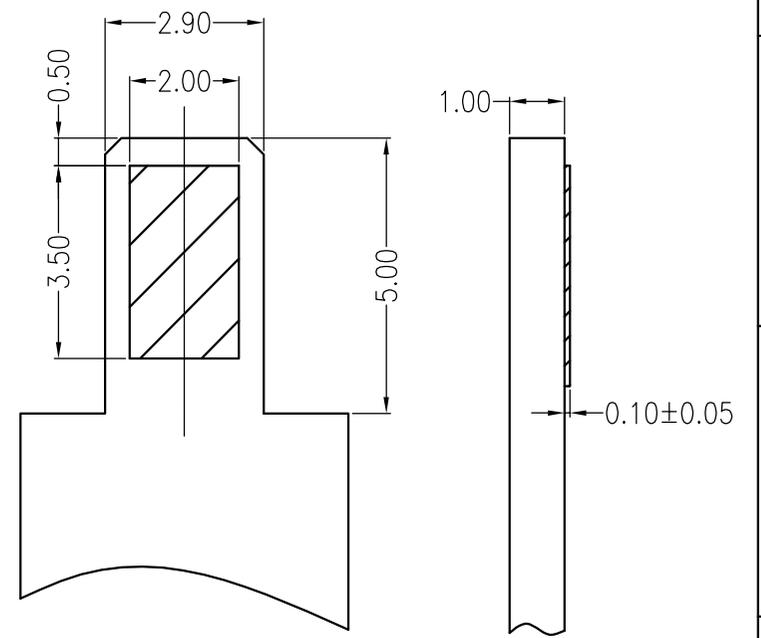
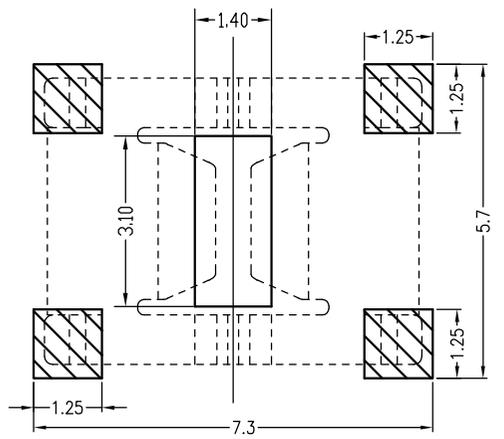


| REV | ECN No. | DESCRIPTION | DESIGN | DATE |
|-----|---------|-------------|--------|------------|
| A0 | | Release | 吴丹平 | 2017.06.14 |



Mating PCB detail

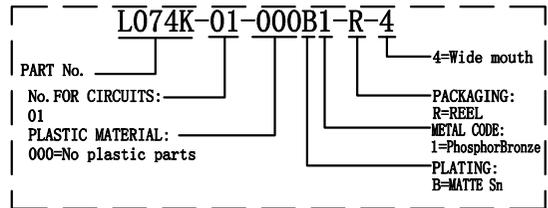


Board Layout

主要技术参数 Main Specifications

- 板厚 (thickness): 1.0mm
- 接触电阻 (Contact resistance): $\leq 20m\Omega$
- 额定电压 (Rated voltage): 250 V AC DC
- 额定电流 (Rated current): 1.0A AC
- 温度范围 (Temperature Range): $-45^{\circ}C \sim +125^{\circ}C$

ORDER INFORMATION:



| ITEM | COMPONENT | Q'TY | MATERIAL | FINISH |
|------|-----------|-------|----------------|-----------------|
| A | CONTACT | 1 PCS | PhosphorBronze | MATTE Sn-plated |

| | | | | |
|--|--------|-------------------------|--|--|
| JKUN 温州健坤接插件有限公司 WENZHOU JKUN CONNECTOR CO., LTD. | | | TITLE: - | |
| X.±0.5 | X.±5' | USE: CUSTOMER | PART NO.: L074K-01-000B1-R-4 | |
| .X±0.3 | .X±2' | | DWG NO.: JKUN-GCCP-1269 | |
| .XX±0.25 | .XX±1' | APPD: 邵敬和 | SCALE 1 : 1 | |
| -- | -- | CHKD: 田峰 | SHEET 1 / 1 | |
| UNITS: mm | | DR: 蒋建银 | | |